

## February 27, 2012

## Main Specifications of Renesas' RL78/L12 MCUs

Item		Specifications						
Group Name		RL78/L12						
Pin-count		32- pin	44-pin	48-pin	52-pin	64-pin		
Code flash memory (Bytes)		8 K, 10	16 K, 32 K					
Data flash memory (Bytes)		2 К						
RAM		1 K, 1.5 K						
	Main system clock	External main system clock input: 1 to 20 MHz High speed on-chip oscillator clock: 24/16/12/8/4/1 MHz						
Clock	Sub system clock	_	XT1 (crystal) oscillation, external subsystem clock 32.768 kHz (TYP.): VDD = 1.6 to 5.5 V					
	Low-speed on- chip oscillator clock	Internal oscillation 15 kHz (TYP.)						
CPU		RL78 CPU core (16-bit CISC CPU) 30 DMIPS (24 MHz operation)						
I/O		20	29	33	37	47		
Timer		16-bit timer: 6 ch "16-bit timer / 8-bit timer: 2 ch": 2 ch						
8/10-bit A/D		4 ch	7 ch	9 ch	10 ch	10 ch		
Serial I/F		UART (LIN-bus supported): 1ch / CSI: 2 ch I <sup>2</sup> C: 1 ch						
LCD controller/driver		Selectable LCD drive power supply (internal voltage boosting method / capacitor split method / external resistance division).						
	Segment signal output	13	22 (18) <sup>Note 1</sup>	26 (22) <sup>Note</sup> 1	30 (26) <sup>Note 1</sup>	39 (35) <sup>Note 1</sup>		
	Common signal	4	4 (8) <sup>Note 1</sup>					

Item		Specifications						
C	output							
External interrupt sources		4	6	7	7	9		
DMA		2 ch						
Other features		Multiplier and divider/multiply accumulator Clock output/buzzer output Watchdog timer (WDT), real-time clock (RTC) Low voltage detection (LVD), power-on reset (POR) Safety functions, on-chip debug function						
Power supply voltage		1.6 to 5.5 V						
Operating ambient temperature		−40°C to +85°C						

\*Note 1: The value inside the parentheses () is the number of segment signal outputs during 8COM operation.

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